



SECT. B-B

SECT. A-A

NOTES.

- 適合ハウジング: 501330-\*\*\*\* / 501939-\*\*\*\*  
APPLICABLE HOUSING: 501330-\*\*\*\* / 501939-\*\*\*\*
- メッキ仕様  
PLATING  
錫メッキ: 1.0μmMIN. リフロー処理(前メッキ)  
Sn: 1.0μmMIN. REFLOW TREATMENT (PRE-PLATED)
- 刻印は裏面から実施  
PUNCH SIDE: OTHER SIDE  
MXJ  金型番号(番号無しの製品もあります.)  
Die No. (There is Non-Mark Item)  
TREAD MARK

|              |              |
|--------------|--------------|
| 501334-0100  | バラ状<br>LOOSE |
| 501334-0000  | 連鎖状<br>CHAIN |
| MATERIAL NO. | 端子形状<br>FORM |

|   |  |  |                            |  |  |                           |
|---|--|--|----------------------------|--|--|---------------------------|
| MATERIAL<br>リン青銅<br>PHOSPHOR BRONZE<br>t=0.12 | REVISED<br>EC NO.: J2009-0651<br>DRW: NAKATA 2008/09/16<br>CHK: MATSUMOTO 2008/09/16<br>APP: NUKITA 2008/09/16 | GENERAL TOLERANCES<br>(UNLESS SPECIFIED)                   | DIMENSION STYLE<br>MM ONLY | SCALE<br>20:1  | DESIGN UNITS<br>METRIC   | THIRD ANGLE<br>PROJECTION |
| FINISH<br>SEE NOTE                            |  | 10 UNDER ±0.2  | DRAWN BY<br>NYOSHIDA       | DATE<br>2004/07/29   | TITLE<br>1.0 WIRE TO BOARD CONN.<br>CRIMP REC TERMINAL (SN)<br>-LEAD FREE- |                           |
| WIRE RANGE<br>AWG #28-32                      |  | 10 OVER 30 UNDER ±0.25                                     | CHECKED BY<br>MYAGI        | DATE<br>2004/07/29   | MOLEX INCORPORATED   |                           |
| INS. RANGE<br>φ0.4-0.8                        |  | 30 OVER ±0.3   | APPROVED BY<br>MIYAZAWA    | DATE<br>2004/07/29   | DOCUMENT NO.<br>SD-501334-001  | SHEET NO.<br>1 OF 1       |
|   |  | ANGULAR ±3°  | MATERIAL NO.<br>SEE TABLE  | THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX<br>INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION |  |                           |
|   |  | DRAFT WHERE APPLICABLE<br>MUST REMAIN<br>WITHIN DIMENSIONS |                            |  |  |                           |